Special Issue

New Trends and Applications in Femtosecond Laser Micromachining

Message from the Guest Editors

Femtosecond laser micromachining has been widely used in many research and industrial fields in applications ranging from material processing to microdevices' fabrication. Indeed, the strong versatility of femtosecond laser micromachining allows working with both transparent and absorptive materials by inducing permanent modifications in the bulk of substrates, by removing material or structuring surfaces or even by growing three-dimensional free-standing structure by direct laser writing. This Special Issue aims to highlight the latest achievements in various applications of femtosecond laser micromachining, with particular interest in new approaches that will pave the way to the future in this technology field. We are looking for research papers, short communications, and review articles that focus on new routes in the exploitation of femtosecond laser machining in the following applications:

- Surface structuring and patterning
- Drilling, cutting and welding
- Multiphoton polymerization
- Lab-on-chip
- Biophotonics
- Integrated optics

Guest Editors

Dr. Rebeca Martínez Vázquez

Dr. Francesca Bragheri

Dr. Petra Paiè

Deadline for manuscript submissions

closed (30 November 2020)



Micromachines

an Open Access Journal by MDPI

Impact Factor 3.0 CiteScore 6.0 Indexed in PubMed



mdpi.com/si/34417

Micromachines
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
micromachines@mdpi.com

mdpi.com/journal/micromachines





an Open Access Journal by MDPI

Impact Factor 3.0
CiteScore 6.0
Indexed in PubMed



About the Journal

Message from the Editor-in-Chief

You are invited to contribute research articles or comprehensive reviews for consideration and publication in *Micromachines* (ISSN 2072-666X). *Micromachines* is published in the open access format. Research articles, reviews and other contents are released on the internet immediately after acceptance. The scientific community and the general public have unlimited free access to the content as soon as it is published. As an open access journal, *Micromachines* is supported by the authors or their institutes by payment of article processing charges (APC) for accepted papers. We are pleased to welcome you as our authors.

Editor-in-Chief

Prof. Dr. Ai-Qun Liu

Department of Electrical and Electronic Engineering, The Hong Kong Polytechnic University, Hong Kong, China

Author Benefits

High Visibility:

indexed within Scopus, SCIE (Web of Science), PubMed, PMC, Ei Compendex, dblp, and other databases.

Journal Rank:

JCR - Q2 (Instruments and Instrumentation) / CiteScore - Q1 (Mechanical Engineering)

Rapid Publication:

manuscripts are peer-reviewed and a first decision is provided to authors approximately 17.2 days after submission; acceptance to publication is undertaken in 1.9 days (median values for papers published in this journal in the first half of 2025).

